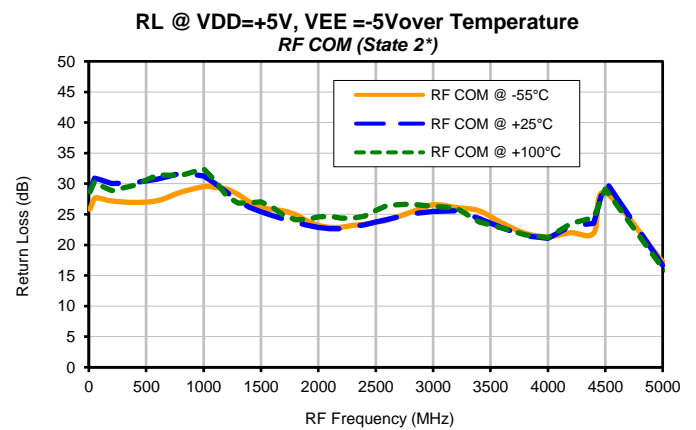
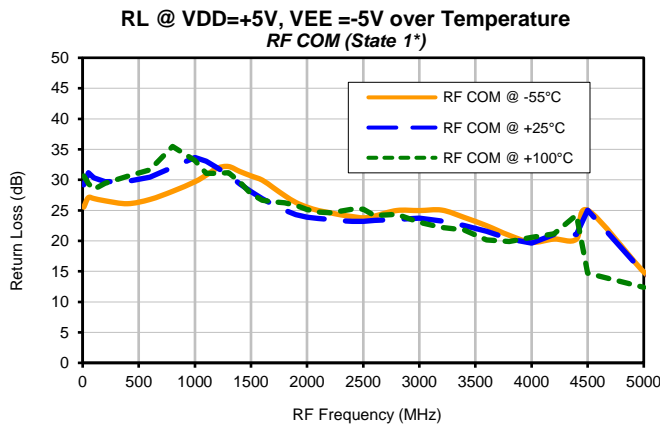
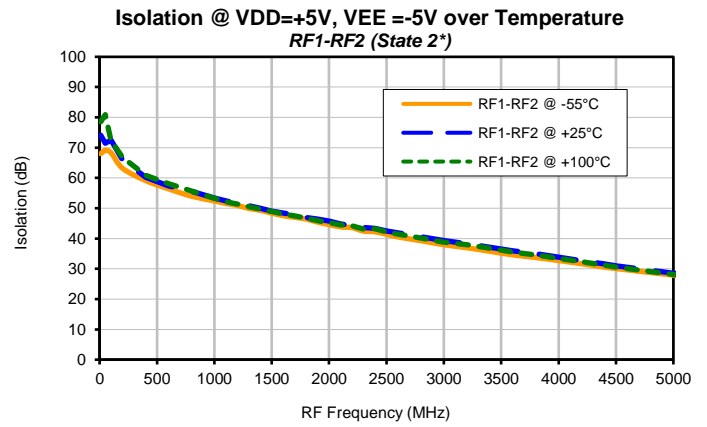
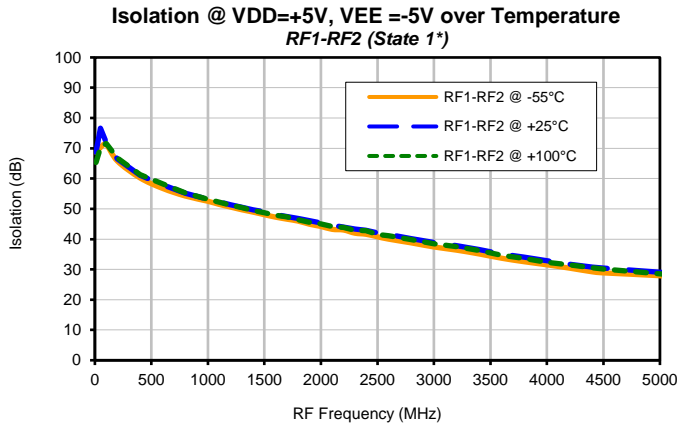
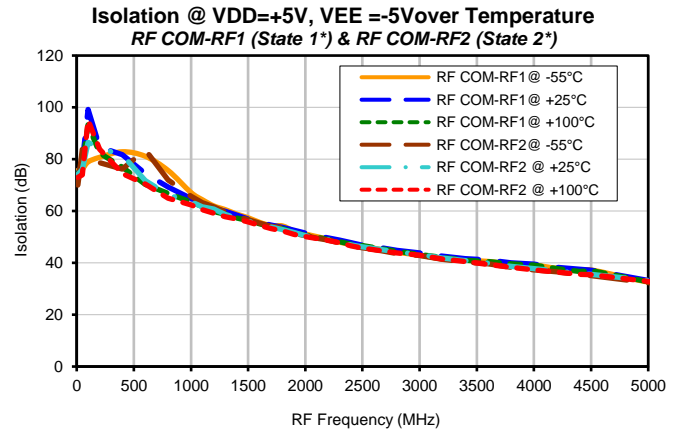
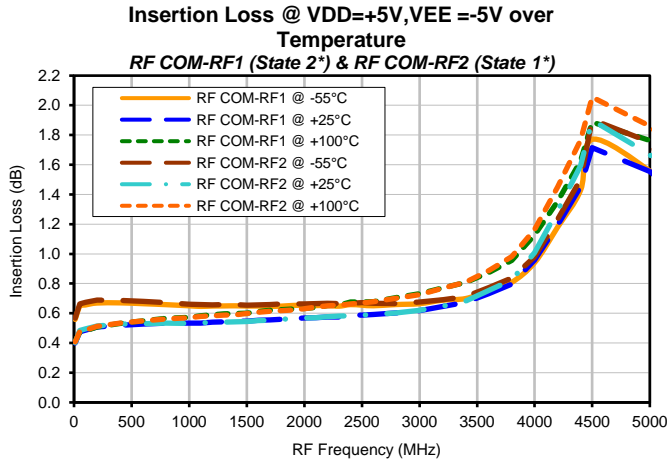


## Typical Performance Data <sup>(1)</sup>

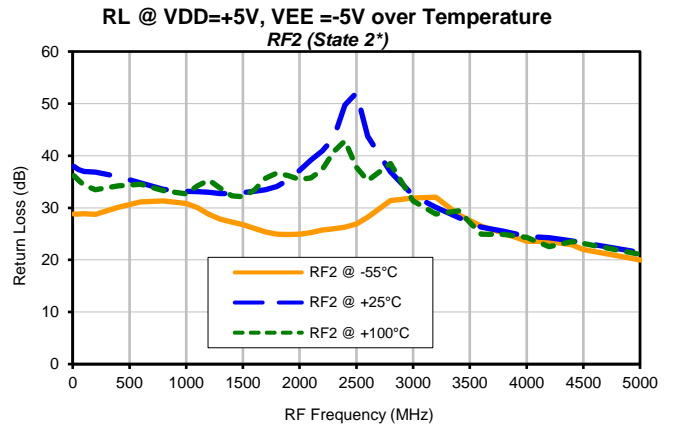
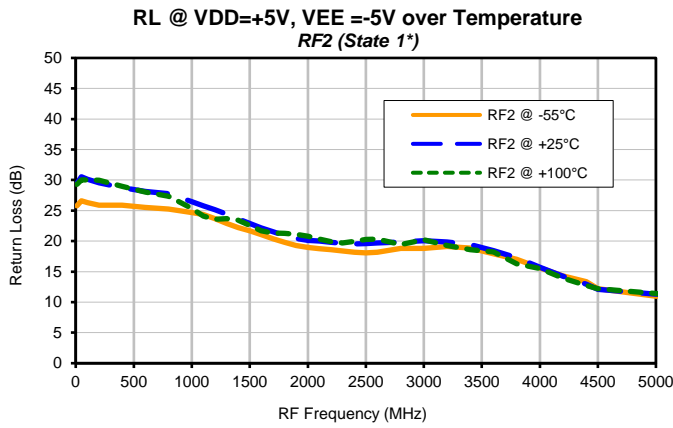
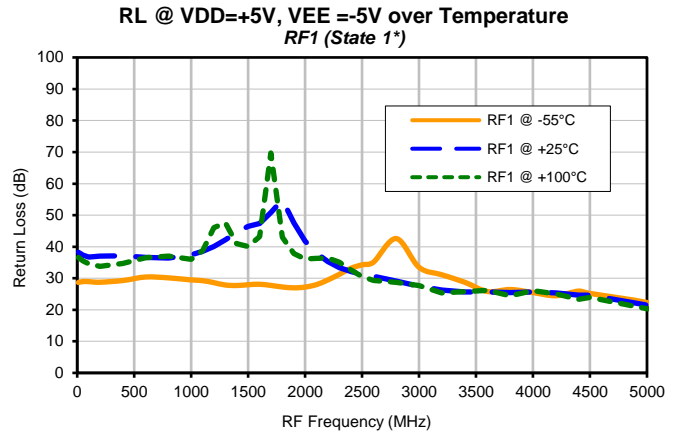
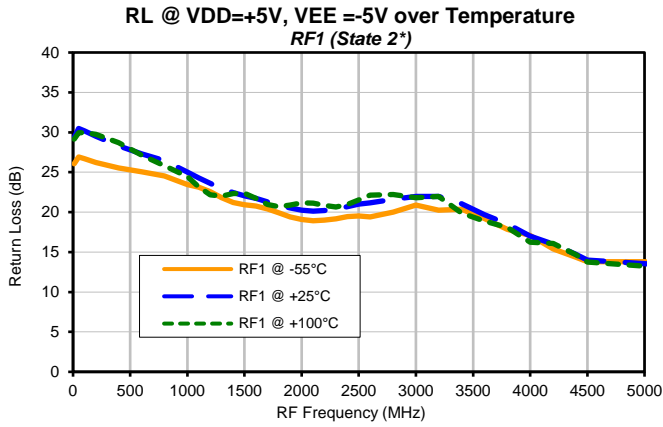


(1) Test data of Die packaged in industry standard, 3.25x3.25 mm, 8-lead MCLP package

\*Note:

STATE	CONTROL INPUT	RF Com to RF1	RF Com to RF2
1	High	OFF	ON
2	Low	ON	OFF

## Typical Performance Data <sup>(1)</sup>



(1) Test data of Die packaged in industry standard, 3.25x3.25 mm, 8-lead MCLP package

\*Note:

STATE	CONTROL INPUT	RF Com to RF1	RF Com to RF2
1	High	OFF	ON
2	Low	ON	OFF